

## AOSP66920

# 100V N-Channel AlphaSGT™

### **General Description**

• Trench Power AlphaSGTTM technology

• Low R<sub>DS(ON)</sub>

Logic Level Driving

• Excellent Q<sub>G</sub> x R<sub>DS(ON)</sub> Product (FOM)

• RoHS and Halogen-Free Compliant

## **Product Summary**

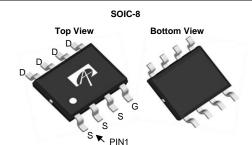
 $\begin{array}{ll} V_{DS} & 100V \\ I_{D} \; (at \, V_{GS} \! = \! 10V) & 13.5A \\ R_{DS(ON)} \; (at \, V_{GS} \! = \! 10V) & < 8.5 m\Omega \\ R_{DS(ON)} \; (at \, V_{GS} \! = \! 4.5V) & < 11 m\Omega \end{array}$ 

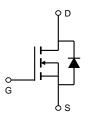
100% UIS Tested 100% Rg Tested



## **Applications**

• High Frequency Switching and Synchronous Rectification





Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOSP66920	SO-8	Tape & Reel	3000

Parameter		Symbol	Maximum	Units	
Drain-Source Voltag	je	V <sub>DS</sub>	100	V	
Gate-Source Voltage		$V_{GS}$	±20	V	
Continuous Drain	T <sub>A</sub> =25°C		13.5		
Current	T <sub>A</sub> =70°C	I <sub>D</sub>	10.5	A	
Pulsed Drain Current <sup>C</sup>		I <sub>DM</sub>	54		
Avalanche Current <sup>(</sup>		I <sub>AS</sub>	38	A	
Avalanche energy	L=0.1mH	E <sub>AS</sub>	72	mJ	
	T <sub>A</sub> =25°C	P <sub>D</sub>	3.1	W	
Power Dissipation <sup>B</sup>	T <sub>A</sub> =70°C	T D	2.0	¬	
Junction and Storag	e Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C	

Thermal Characteristics							
Parameter	Symbol	Тур	Max	Units			
Maximum Junction-to-Ambient A	t ≤ 10s		31	40	°C/W		
Maximum Junction-to-Ambient AD	Steady-State	$R_{\theta JA}$	59	75	°C/W		
Maximum Junction-to-Lead	Steady-State	$R_{\theta JL}$	16	24	°C/W		



#### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
STATIC I	PARAMETERS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$		100			V
1	Zero Gate Voltage Drain Current	$V_{DS}$ =100V, $V_{GS}$ =0V			1		
I <sub>DSS</sub>			T <sub>J</sub> =55°C			5	μA
I <sub>GSS</sub>	Gate-Body leakage current	$V_{DS}$ =0V, $V_{GS}$ =±20V				±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$		1.5	2.0	2.5	V
	Static Drain-Source On-Resistance	$V_{GS}$ =10V, $I_{D}$ =13.5A			7.0	8.5	mΩ
R <sub>DS(ON)</sub>			T <sub>J</sub> =125°C		12	14.5	
		$V_{GS}$ =4.5V, $I_{D}$ =11.5A			8.8	11	mΩ
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =13.5A			60		S
$V_{SD}$	Diode Forward Voltage	I <sub>S</sub> =1A, V <sub>GS</sub> =0V			0.7	1	V
I <sub>S</sub>	Maximum Body-Diode Continuous Cur	Body-Diode Continuous Current				4	Α
DYNAMI	C PARAMETERS		-				-
C <sub>iss</sub>	Input Capacitance			2500		pF	
Coss	Output Capacitance	$V_{GS}$ =0V, $V_{DS}$ =50V, f=1MHz f=1MHz			485		pF
$C_{rss}$	Reverse Transfer Capacitance				13		pF
$R_g$	Gate resistance			0.5	1.1	1.8	Ω
SWITCHI	NG PARAMETERS						
<b>Q</b> <sub>g</sub> (10V)	Total Gate Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V, I <sub>D</sub> =13.5A			35	50	nC
Q <sub>g</sub> (4.5V)	Total Gate Charge				16.7	25	nC
$Q_{gs}$	Gate Source Charge				8		nC
$Q_{gd}$	Gate Drain Charge				5		nC
Q <sub>oss</sub>	Output Charge	$V_{GS}$ =0V, $V_{DS}$ =50V			44		nC
t <sub>D(on)</sub>	Turn-On DelayTime	$V_{GS}$ =10V, $V_{DS}$ =50V, $R_L$ =3.7 $\Omega$ , $R_{GEN}$ =3 $\Omega$			10		ns
t <sub>r</sub>	Turn-On Rise Time				4		ns
t <sub>D(off)</sub>	Turn-Off DelayTime				31		ns
t <sub>f</sub>	Turn-Off Fall Time			_	6		ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =13.5A, di/dt=500A/μs			30		ns
$Q_{rr}$	Body Diode Reverse Recovery Charge	<sub>g</sub> I <sub>F</sub> =13.5A, di/dt=500A/μs			150		nC

A. The value of  $R_{\text{BJA}}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^{\circ}$  C. The

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value in any given application depends on the user's specific board design. B. The power dissipation  $P_D$  is based on  $T_{J(MAX)}=150^\circ$  C, using  $\leq 10$ s junction-to-ambient thermal resistance. C. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}=150^\circ$  C. Ratings are based on low frequency and duty cycles to keep initial $T_J$ =25° C.

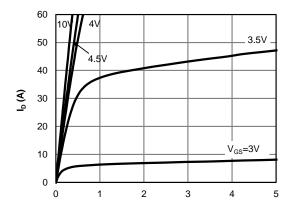
D. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max.

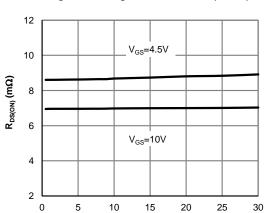
F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on  $1ir^2$  FR-4 board with 2oz. Copper, assuming a maximum junction temperature of  $T_{J(MAX)}$ =150° C. The SOA curve provides a single pulse rating.



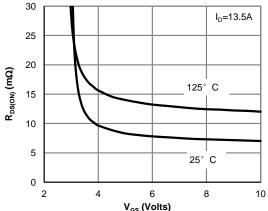
#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



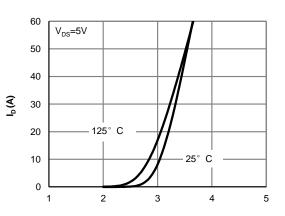
V<sub>DS</sub> (Volts) Figure 1: On-Region Characteristics (Note E)



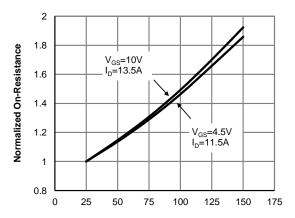
 $\rm I_D \, (A)$  Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)



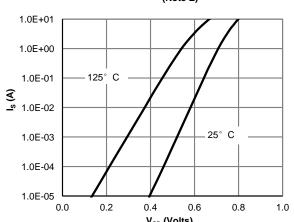
V<sub>GS</sub> (Volts)
Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)



V<sub>GS</sub> (Volts) Figure 2: Transfer Characteristics (Note E)



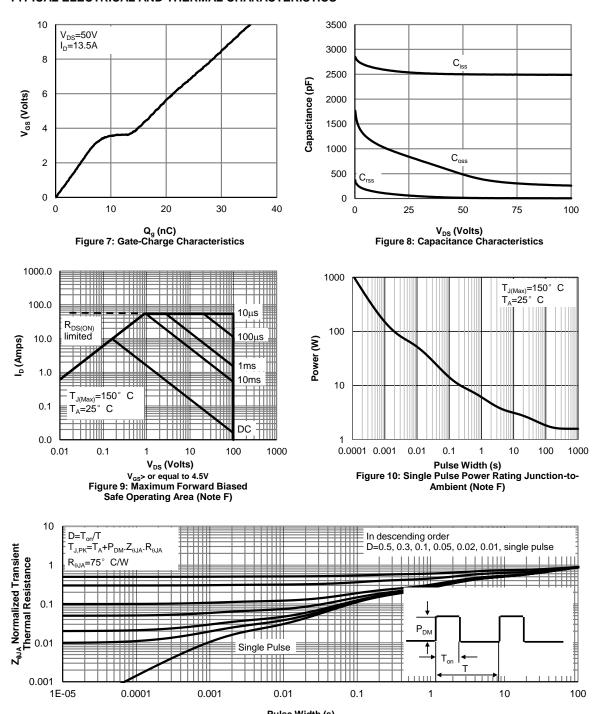
Temperature (°C)
Figure 4: On-Resistance vs. Junction Temperature
(Note E)



V<sub>SD</sub> (Volts) Figure 6: Body-Diode Characteristics (Note E)



#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

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Figure A: Gate Charge Test Circuit & Waveforms

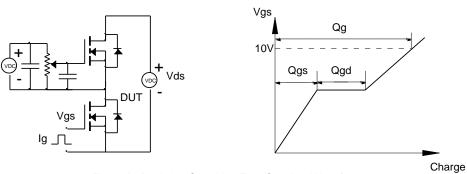


Figure B: Resistive Switching Test Circuit & Waveforms

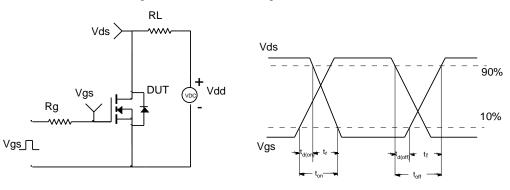


Figure C: Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

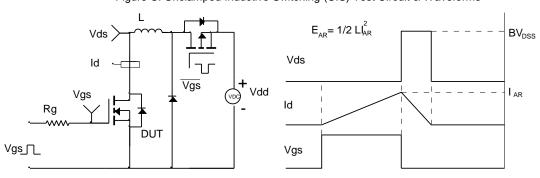
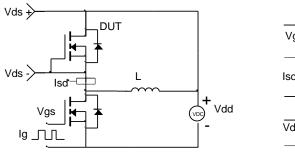
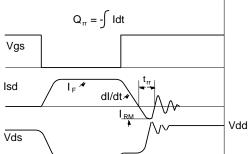


Figure D: Diode Recovery Test Circuit & Waveforms





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